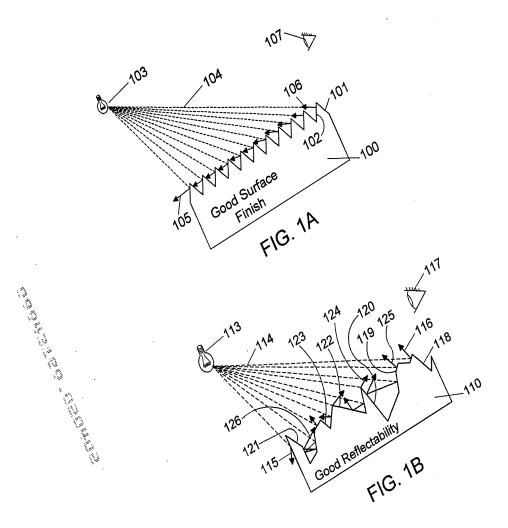
115



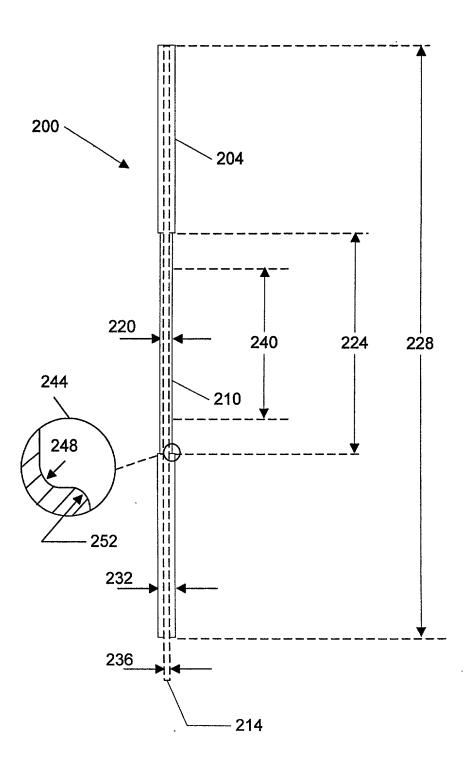


FIG. 2

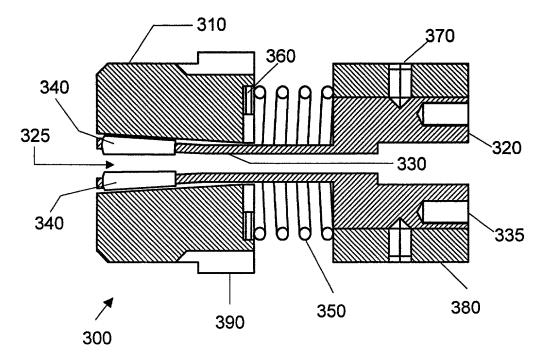


FIG. 3

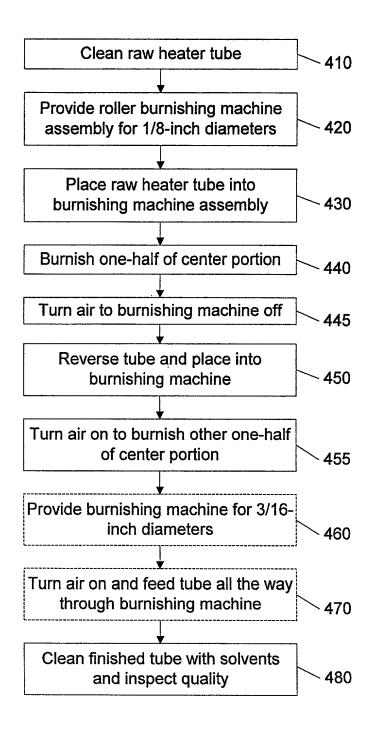


FIG. 4

^{5/5} FIG. 5

Mode Wavelength : Spi : 1510.0nm - G1 : 70.00°

Angle

Thickness

1510.0nm k

Film 1 Substrate

20.00nm

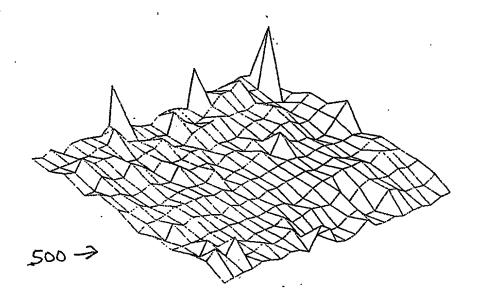
1.450 0.000 2.650 -9.400

Wafer Size/Edge : 200x200 mm / 0.0 mm Start Coord X/Y : 1.000 / 1.000 mm End Coord X/Y : 111.000 / 12.000 mm Point Count X/Y : 25 / 12 Measure Time : 14:08:20 Measure Date : 01/09/99 Wafer Id : BLANK Filename : SD.RSM

Thick t

Swivel Angle: 40°

Tilt Angle : 70°



Volume :

-9.13E-06 ccm

		Mean	Sigma 1	Sigma 3	Range	Minimum ·	Maximum
Psj	1	34.0672°	0.5208°	1.5625°	2.5903°	33.1626°	35.7529°
Delta		161.9622°	0.5631°	1.6894°	4.5595°	158.4595°	163.0190°
Thick		-16.25nm	0.91mm	2.72nm	7.37nm	-17.96nm	-10.59mm